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Kind regards,

Team Nexperia



# **BC847DS** 45 V, 100 mA NPN/NPN general-purpose transistorRev. 01 — 25 August 2009Production

Product data sheet

#### **Product profile** 1.

### 1.1 General description

NPN/NPN general-purpose transistor pair in a small SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package.

#### 1.2 Features

- Low collector capacitance
- Low collector-emitter saturation voltage
- Closely matched current gain
- Reduces number of components and board space
- No mutual interference between the transistors
- AEC-Q101 qualified

#### **1.3 Applications**

General-purpose switching and amplification

### 1.4 Quick reference data

#### Quick reference data Table 1.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	45	V
I <sub>C</sub>	collector current		-	-	100	mA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = 5 V; $I_C$ = 2 mA	200	300	450	



#### 45 V, 100 mA NPN/NPN general-purpose transistor

# 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1		
3	collector TR2	0	
4	emitter TR2		
5	base TR2		
6	collector TR1		1 2 3
			sym020

# 3. Ordering information

Table 3. Order	ring inform	ation	
Type number	Package		
	Name	Description	Version
BC847DS	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457

### 4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
BC847DS		ZL

# 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	tor				
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	45	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	6	V
I <sub>C</sub>	collector current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	200	mA
I <sub>BM</sub>	peak base current	single pulse; $t_p \leq 1 ms$	-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	250	mW
Per device					
P <sub>tot</sub>	total power dissipation	$T_{amb} \leq 25 \ ^{\circ}C$	<u>[1]</u> -	380	mW

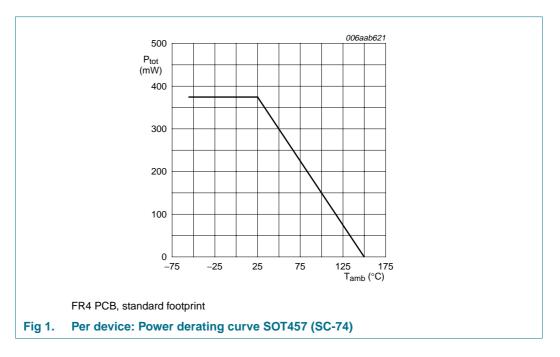
#### 45 V, 100 mA NPN/NPN general-purpose transistor

#### Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

			-		
Symbol	Parameter	Conditions	Min	Max	Unit
Тj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



# 6. Thermal characteristics

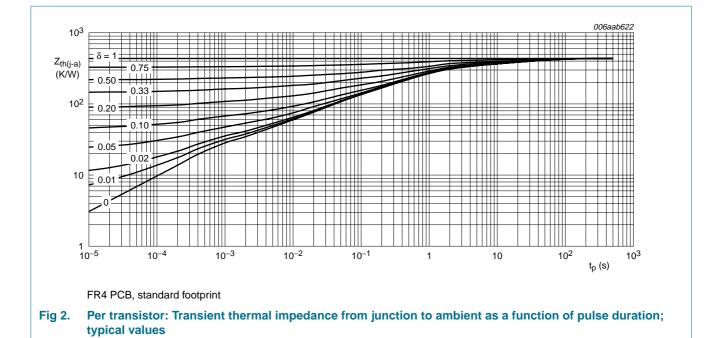
Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	500	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	250	K/W
Per devic	e					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	328	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

#### **NXP Semiconductors**

# BC847DS

#### 45 V, 100 mA NPN/NPN general-purpose transistor



## 7. Characteristics

#### Table 7.Characteristics

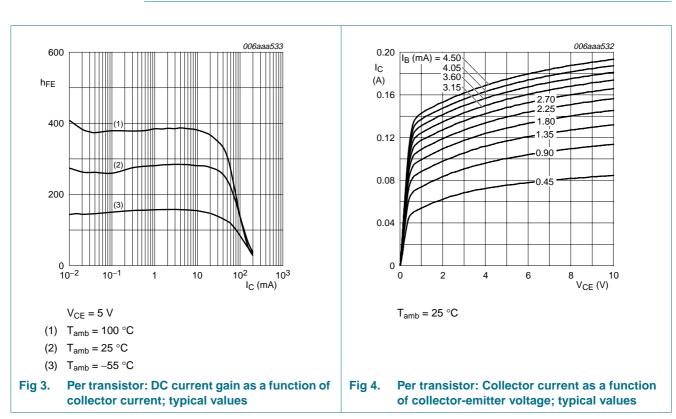
 $T_{amb} = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per trans	sistor					
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	15	nA
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	5	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 6 V; I_C = 0 A$	-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 V$				
		I <sub>C</sub> = 10 μA	-	280	-	
		$I_{\rm C} = 2  \rm mA$	200	300	450	
V <sub>CEsat</sub>	collector-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	55	100	mV
	saturation voltage	I <sub>C</sub> = 100 mA; I <sub>B</sub> = 5 mA	-	200	300	mV
V <sub>BEsat</sub>	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	755	850	mV
	saturation voltage	I <sub>C</sub> = 100 mA; I <sub>B</sub> = 5 mA	-	1000	-	mV
V <sub>BE</sub>	base-emitter voltage	$V_{CE} = 5 V$				
		$I_{\rm C} = 2  \rm mA$	580	650	700	mV
		I <sub>C</sub> = 10 mA	-	-	770	mV

#### 45 V, 100 mA NPN/NPN general-purpose transistor

' amb - 20	<sup>5</sup> <sup>c</sup> unless otherwise s					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz	-	1.9	-	pF
C <sub>e</sub>	emitter capacitance	$\label{eq:Veb} \begin{split} V_{EB} &= 0.5 \text{ V}; \text{ I}_{C} = \text{i}_{c} = 0 \text{ A}; \\ \text{f} &= 1 \text{ MHz} \end{split}$	-	11	-	pF
f <sub>T</sub>	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 10 \text{ mA};$ f = 100 MHz	100	-	-	MHz
NF	noise figure		-	1.9	-	dB
		$V_{CE} = 5 \text{ V}; I_C = 0.2 \text{ mA};$ $R_S = 2 \text{ k}\Omega; f = 1 \text{ kHz};$ B = 200  Hz	-	3.1	-	dB

#### Characteristics ... continued Table 7.

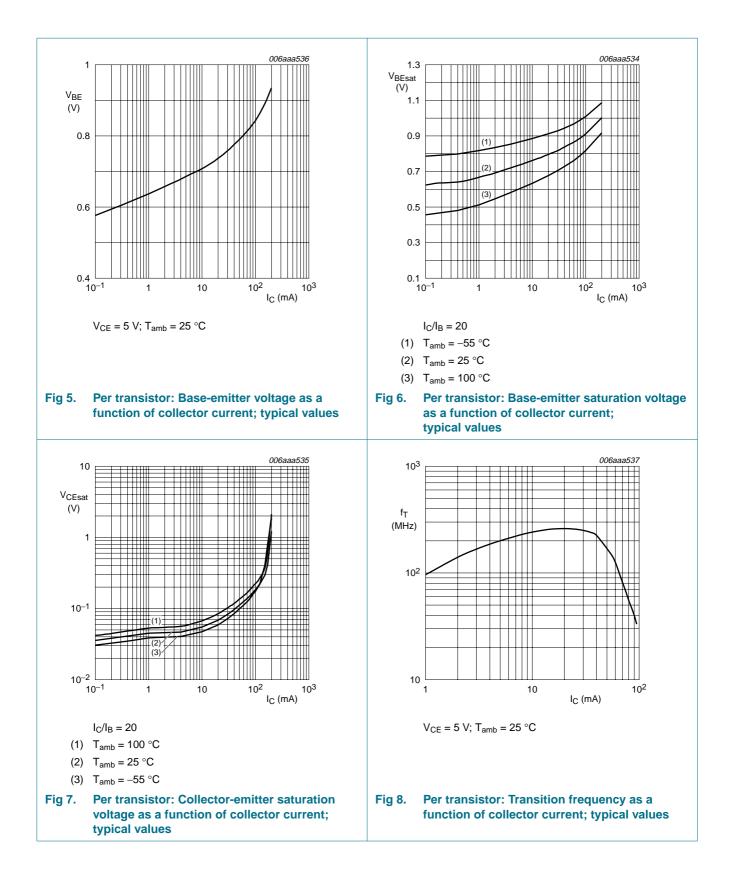


# $T_{omb} = 25 \,^{\circ}C$ unless otherwise specified

#### **NXP Semiconductors**

# BC847DS

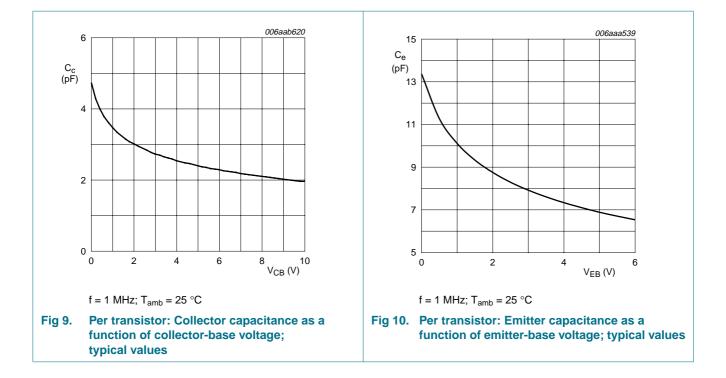
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#### 45 V, 100 mA NPN/NPN general-purpose transistor



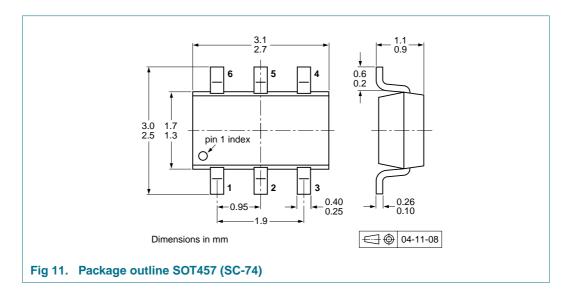
#### 45 V, 100 mA NPN/NPN general-purpose transistor

### 8. Test information

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### 9. Package outline



# **10. Packing information**

#### Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	number Package Description			Packing	quantity
				3000	10000
BC847DS	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	<u>[3]</u>	-125	-165

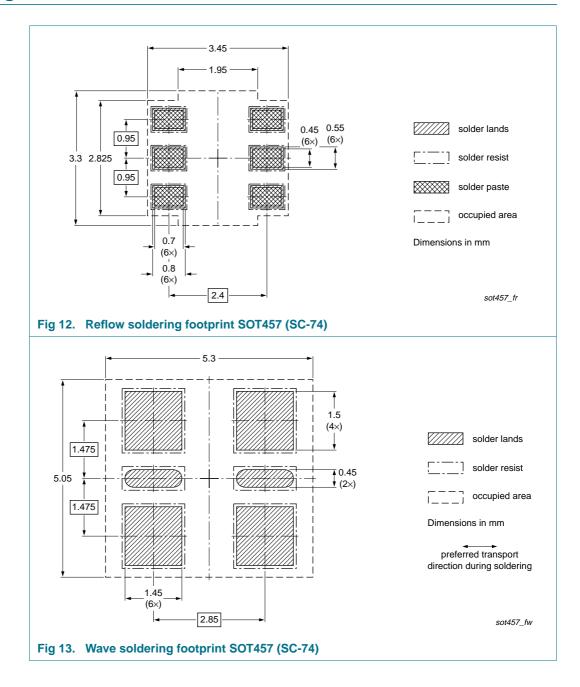
[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

[3] T2: reverse taping

45 V, 100 mA NPN/NPN general-purpose transistor

# **11. Soldering**



#### 45 V, 100 mA NPN/NPN general-purpose transistor

# 12. Revision history

Table 9. Revis	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BC847DS_1	20090825	Product data sheet	-	-	

# **13. Legal information**

#### **13.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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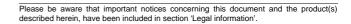
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BC847DS\_1 Product data sheet

#### 45 V, 100 mA NPN/NPN general-purpose transistor

# **15. Contents**

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data
2	Pinning information 2
3	Ordering information 2
4	Marking
5	Limiting values 2
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 8
8.1	Quality information 8
9	Package outline 8
10	Packing information 8
11	Soldering 9
12	Revision history 10
13	Legal information 11
13.1	Data sheet status 11
13.2	Definitions 11
13.3	Disclaimers
13.4	Trademarks 11
14	Contact information 11
15	Contents 12



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